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### [Understanding Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	1452
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	180
Number of Gates	24000
Voltage - Supply	2.25V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	256-LBGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microsemi/a54sx16a-fgg256">https://www.e-xfl.com/product-detail/microsemi/a54sx16a-fgg256</a>

## Temperature Grade Offering

Package	A54SX08A	A54SX16A	A54SX32A	A54SX72A
PQ208	C,I,A,M	C,I,A,M	C,I,A,M	C,I,A,M
TQ100	C,I,A,M	C,I,A,M	C,I,A,M	
TQ144	C,I,A,M	C,I,A,M	C,I,A,M	
TQ176			C,I,M	
BG329			C,I,M	
FG144	C,I,A,M	C,I,A,M	C,I,A,M	
FG256		C,I,A,M	C,I,A,M	C,I,A,M
FG484			C,I,M	C,I,A,M
CQ208			C,M,B	C,M,B
CQ256			C,M,B	C,M,B

**Notes:**

1. C = Commercial
2. I = Industrial
3. A = Automotive
4. M = Military
5. B = MIL-STD-883 Class B
6. For more information regarding automotive products, refer to the SX-A Automotive Family FPGAs datasheet.
7. For more information regarding Mil-Temp and ceramic packages, refer to the HiRel SX-A Family FPGAs datasheet.

## Speed Grade and Temperature Grade Matrix

	F	Std	-1	-2	-3
Commercial	✓	✓	✓	✓	Discontinued
Industrial		✓	✓	✓	Discontinued
Automotive		✓			
Military		✓	✓		
MIL-STD-883B		✓	✓		

**Notes:**

1. For more information regarding automotive products, refer to the SX-A Automotive Family FPGAs datasheet.
2. For more information regarding Mil-Temp and ceramic packages, refer to the HiRel SX-A Family FPGAs datasheet.

Contact your Actel Sales representative for more information on availability.

## Clock Resources

Actel's high-drive routing structure provides three clock networks (Table 1-1). The first clock, called HCLK, is hardwired from the HCLK buffer to the clock select multiplexor (MUX) in each R-cell. HCLK cannot be connected to combinatorial logic. This provides a fast propagation path for the clock signal. If not used, this pin must be set as Low or High on the board. It must not be left floating. Figure 1-7 describes the clock circuit used for the constant load HCLK and the macros supported.

HCLK does not function until the fourth clock cycle each time the device is powered up to prevent false output levels due to any possible slow power-on-reset signal and fast start-up clock circuit. To activate HCLK from the first cycle, the TRST pin must be reserved in the Design software and the pin must be tied to GND on the board.

Two additional clocks (CLKA, CLKB) are global clocks that can be sourced from external pins or from internal logic signals within the SX-A device. CLKA and CLKB may be connected to sequential cells or to combinational logic. If CLKA or CLKB pins are not used or sourced from signals, these pins must be set as Low or High on the board. They must not be left floating. Figure 1-8 describes the CLKA

and CLKB circuit used and the macros supported in SX-A devices with the exception of A54SX72A.

In addition, the A54SX72A device provides four quadrant clocks (QCLKA, QCLKB, QCLKC, and QCLKD—corresponding to bottom-left, bottom-right, top-left, and top-right locations on the die, respectively), which can be sourced from external pins or from internal logic signals within the device. Each of these clocks can individually drive up to an entire quadrant of the chip, or they can be grouped together to drive multiple quadrants (Figure 1-9 on page 1-6). QCLK pins can function as user I/O pins. If not used, the QCLK pins must be tied Low or High on the board and must not be left floating.

For more information on how to use quadrant clocks in the A54SX72A device, refer to the *Global Clock Networks in Actel's Antifuse Devices* and *Using A54SX72A and RT54SX72S Quadrant Clocks* application notes.

The CLKA, CLKB, and QCLK circuits for A54SX72A as well as the macros supported are shown in Figure 1-10 on page 1-6. Note that bidirectional clock buffers are only available in A54SX72A. For more information, refer to the "Pin Description" section on page 1-15.

Table 1-1 • SX-A Clock Resources

	<b>A54SX08A</b>	<b>A54SX16A</b>	<b>A54SX32A</b>	<b>A54SX72A</b>
Routed Clocks (CLKA, CLKB)	2	2	2	2
Hardwired Clocks (HCLK)	1	1	1	1
Quadrant Clocks (QCLKA, QCLKB, QCLKC, QCLKD)	0	0	0	4

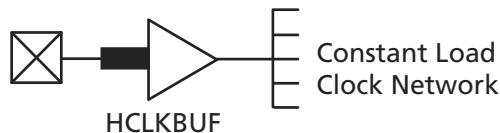


Figure 1-7 • SX-A HCLK Clock Buffer

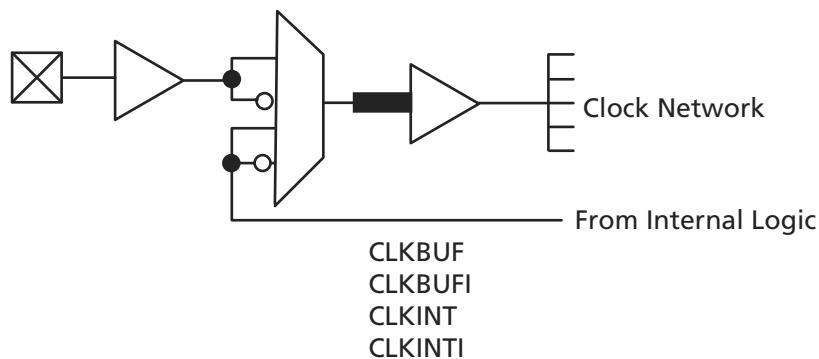


Figure 1-8 • SX-A Routed Clock Buffer

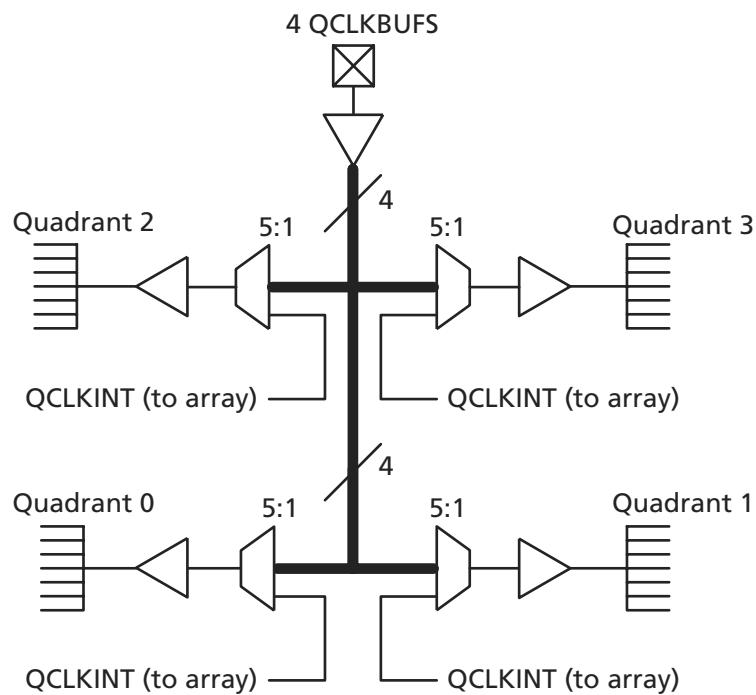


Figure 1-9 • SX-A QCLK Architecture

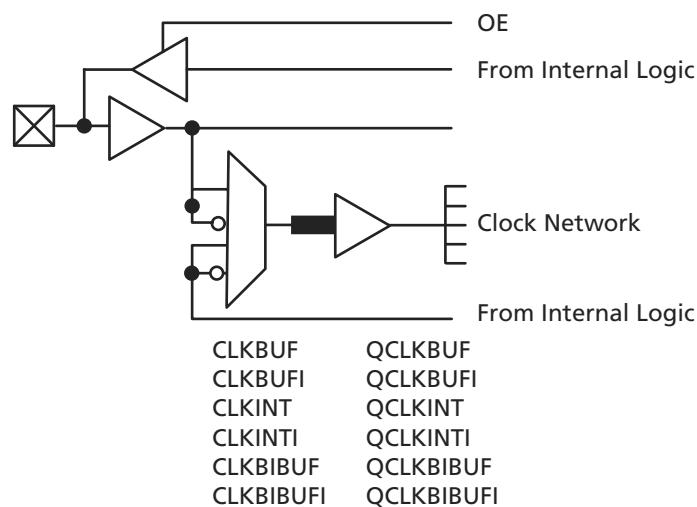


Figure 1-10 • A54SX72A Routed Clock and QCLK Buffer

## Power-Up/Down and Hot Swapping

SX-A I/Os are configured to be hot-swappable, with the exception of 3.3 V PCI. During power-up/down (or partial up/down), all I/Os are tristated.  $V_{CCA}$  and  $V_{CCI}$  do not have to be stable during power-up/down, and can be powered up/down in any order. When the SX-A device is plugged into an electrically active system, the device will not degrade the reliability of or cause damage to the host system. The device's output pins are driven to a high impedance state until normal chip operating conditions

are reached. Table 1-4 summarizes the  $V_{CCA}$  voltage at which the I/Os behave according to the user's design for an SX-A device at room temperature for various ramp-up rates. The data reported assumes a linear ramp-up profile to 2.5 V. For more information on power-up and hot-swapping, refer to the application note, *Actel SX-A and RT54SX-S Devices in Hot-Swap and Cold-Sparing Applications*.

Table 1-2 • I/O Features

Function	Description
Input Buffer Threshold Selections	<ul style="list-style-type: none"> <li>• 5 V: PCI, TTL</li> <li>• 3.3 V: PCI, LVTTL</li> <li>• 2.5 V: LVCMOS2 (commercial only)</li> </ul>
Flexible Output Driver	<ul style="list-style-type: none"> <li>• 5 V: PCI, TTL</li> <li>• 3.3 V: PCI, LVTTL</li> <li>• 2.5 V: LVCMOS2 (commercial only)</li> </ul>
Output Buffer	<p>"Hot-Swap" Capability (3.3 V PCI is not hot swappable)</p> <ul style="list-style-type: none"> <li>• I/O on an unpowered device does not sink current</li> <li>• Can be used for "cold-sparing"</li> </ul> <p>Selectable on an individual I/O basis</p> <p>Individually selectable slew rate; high slew or low slew (The default is high slew rate). The slew is only affected on the falling edge of an output. Rising edges of outputs are not affected.</p>
Power-Up	<p>Individually selectable pull-ups and pull-downs during power-up (default is to power-up in tristate)</p> <p>Enables deterministic power-up of device</p> <p><math>V_{CCA}</math> and <math>V_{CCI}</math> can be powered in any order</p>

Table 1-3 • I/O Characteristics for All I/O Configurations

	Hot Swappable	Slew Rate Control	Power-Up Resistor
TTL, LVTTL, LVCMOS2	Yes	Yes. Only affects falling edges of outputs	Pull-up or pull-down
3.3 V PCI	No	No. High slew rate only	Pull-up or pull-down
5 V PCI	Yes	No. High slew rate only	Pull-up or pull-down

Table 1-4 • Power-Up Time at which I/Os Become Active

Supply Ramp Rate	0.25 V/ $\mu$ s	0.025 V/ $\mu$ s	5 V/ms	2.5 V/ms	0.5 V/ms	0.25 V/ms	0.1 V/ms	0.025 V/ms
Units	$\mu$ s	$\mu$ s	ms	ms	ms	ms	ms	ms
A54SX08A	10	96	0.34	0.65	2.7	5.4	12.9	50.8
A54SX16A	10	100	0.36	0.62	2.5	4.7	11.0	41.6
A54SX32A	10	100	0.46	0.74	2.8	5.2	12.1	47.2
A54SX72A	10	100	0.41	0.67	2.6	5.0	12.1	47.2



Figure 2-1 shows the 5 V PCI V/I curve and the minimum and maximum PCI drive characteristics of the SX-A family.

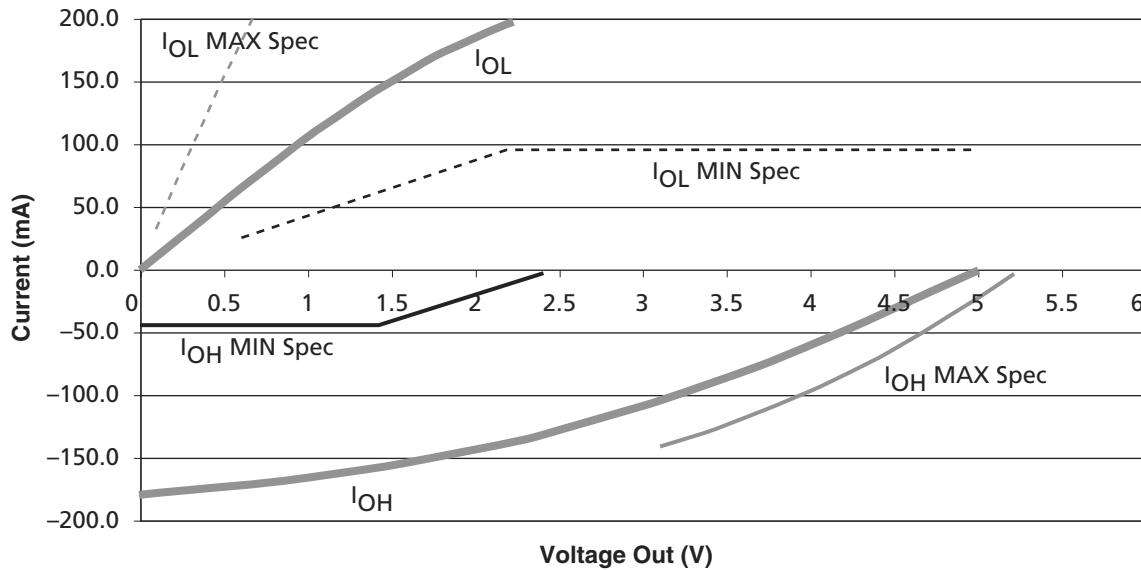


Figure 2-1 • 5 V PCI V/I Curve for SX-A Family

$$I_{OH} = 11.9 * (V_{OUT} - 5.25) * (V_{OUT} + 2.45)$$

for  $V_{CCI} > V_{OUT} > 3.1V$

EQ 2-1

$$I_{OL} = 78.5 * V_{OUT} * (4.4 - V_{OUT})$$

for  $0V < V_{OUT} < 0.71V$

EQ 2-2

Table 2-9 • DC Specifications (3.3 V PCI Operation)

Symbol	Parameter	Condition	Min.	Max.	Units
$V_{CCA}$	Supply Voltage for Array		2.25	2.75	V
$V_{CCI}$	Supply Voltage for I/Os		3.0	3.6	V
$V_{IH}$	Input High Voltage		$0.5V_{CCI}$	$V_{CCI} + 0.5$	V
$V_{IL}$	Input Low Voltage		-0.5	$0.3V_{CCI}$	V
$I_{IPU}$	Input Pull-up Voltage <sup>1</sup>		$0.7V_{CCI}$	-	V
$I_{IL}$	Input Leakage Current <sup>2</sup>	$0 < V_{IN} < V_{CCI}$	-10	+10	$\mu A$
$V_{OH}$	Output High Voltage	$I_{OUT} = -500 \mu A$	$0.9V_{CCI}$	-	V
$V_{OL}$	Output Low Voltage	$I_{OUT} = 1,500 \mu A$		$0.1V_{CCI}$	V
$C_{IN}$	Input Pin Capacitance <sup>3</sup>		-	10	pF
$C_{CLK}$	CLK Pin Capacitance		5	12	pF

#### Notes:

1. This specification should be guaranteed by design. It is the minimum voltage to which pull-up resistors are calculated to pull a floated network. Designers should ensure that the input buffer is conducting minimum current at this input voltage in applications sensitive to static power utilization.
2. Input leakage currents include hi-Z output leakage for all bidirectional buffers with tristate outputs.
3. Absolute maximum pin capacitance for a PCI input is 10 pF (except for CLK).

Table 2-18 • A54SX08A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.3\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>		<b>-F Speed</b>		<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>2.5 V LVCMOS Output Module Timing<sup>1,2</sup></b>										
$t_{DLH}$	Data-to-Pad Low to High	3.9	4.4	5.2	7.2	ns				
$t_{DHL}$	Data-to-Pad High to Low	3.0	3.4	3.9	5.5	ns				
$t_{DHLS}$	Data-to-Pad High to Low—low slew	13.3	15.1	17.7	24.8	ns				
$t_{ENZL}$	Enable-to-Pad, Z to L	2.8	3.2	3.7	5.2	ns				
$t_{ENZLS}$	Data-to-Pad, Z to L—low slew	13.7	15.5	18.2	25.5	ns				
$t_{ENZH}$	Enable-to-Pad, Z to H	3.9	4.4	5.2	7.2	ns				
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.5	2.8	3.3	4.7	ns				
$t_{ENHZ}$	Enable-to-Pad, H to Z	3.0	3.4	3.9	5.5	ns				
$d_{TLH}^3$	Delta Low to High	0.037	0.043	0.051	0.071	ns/pF				
$d_{THL}^3$	Delta High to Low	0.017	0.023	0.023	0.037	ns/pF				
$d_{THLS}^3$	Delta High to Low—low slew	0.06	0.071	0.086	0.117	ns/pF				

**Note:**

1. Delays based on 35 pF loading.
2. The equivalent I/O Attribute Editor settings for 2.5 V LVCMOS is 2.5 V LVTTL in the software.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF.  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.

Table 2-23 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.0	1.1	1.3	1.5	2.2	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{HCKSW}$	Maximum Skew	0.3	0.3	0.4	0.4	0.6	ns
$t_{HP}$	Minimum Period	2.8	3.4	3.8	4.4	6.0	ns
$f_{HMAX}$	Maximum Frequency	357	294	263	227	167	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.0	1.2	1.3	1.5	2.1	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.1	1.3	1.4	1.7	2.3	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.7	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.0	1.1	1.3	1.5	2.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-24 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.0	1.1	1.2	1.5	2.2	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{HCKSW}$	Maximum Skew	0.3	0.3	0.4	0.4	0.7	ns
$t_{HP}$	Minimum Period	2.8	3.4	3.8	4.4	6.0	ns
$f_{HMAX}$	Maximum Frequency	357	294	263	227	167	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.0	1.2	1.3	1.6	2.2	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.0	1.1	1.3	1.5	2.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-25 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	
<b>2.5 V LVC MOS Output Module Timing<sup>2, 3</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	3.4	3.9	4.5	5.2	7.3	ns
$t_{DHL}$	Data-to-Pad High to Low	2.6	3.0	3.3	3.9	5.5	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	11.6	13.4	15.2	17.9	25.0	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.4	2.8	3.2	3.7	5.2	ns
$t_{ENZLS}$	Data-to-Pad, Z to L—low slew	11.8	13.7	15.5	18.2	25.5	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	3.4	3.9	4.5	5.2	7.3	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.1	2.5	2.8	3.3	4.7	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.6	3.0	3.3	3.9	5.5	ns
$d_{TLH}^4$	Delta Low to High	0.031	0.037	0.043	0.051	0.071	ns/pF
$d_{THL}^4$	Delta High to Low	0.017	0.017	0.023	0.023	0.037	ns/pF
$d_{THLS}^4$	Delta High to Low—low slew	0.057	0.06	0.071	0.086	0.117	ns/pF

**Note:**

1. All -3 speed grades have been discontinued.
2. Delays based on 35 pF loading.
3. The equivalent IO Attribute settings for 2.5 V LVC MOS is 2.5 V LVTTL in the software.
4. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.

Table 2-32 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.3\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	
<b>2.5 V LVC MOS Output Module Timing<sup>2,3</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	3.3	3.8	4.2	5.0	7.0	ns
$t_{DHL}$	Data-to-Pad High to Low	2.5	2.9	3.2	3.8	5.3	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	11.1	12.8	14.5	17.0	23.8	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.4	2.8	3.2	3.7	5.2	ns
$t_{ENZLS}$	Data-to-Pad, Z to L—low slew	11.8	13.7	15.5	18.2	25.5	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	3.3	3.8	4.2	5.0	7.0	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.1	2.5	2.8	3.3	4.7	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.5	2.9	3.2	3.8	5.3	ns
$d_{TLH}^4$	Delta Low to High	0.031	0.037	0.043	0.051	0.071	ns/pF
$d_{THL}^4$	Delta High to Low	0.017	0.017	0.023	0.023	0.037	ns/pF
$d_{THLS}^4$	Delta High to Low—low slew	0.057	0.06	0.071	0.086	0.117	ns/pF

**Note:**

1. All -3 speed grades have been discontinued.
2. Delays based on 35 pF loading.
3. The equivalent IO Attribute settings for 2.5 V LVC MOS is 2.5 V LVTTL in the software.
4. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.

Table 2-34 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>5 V PCI Output Module Timing<sup>2</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	2.1	2.4	2.8	3.2	4.5	ns
$t_{DHL}$	Data-to-Pad High to Low	2.8	3.2	3.6	4.2	5.9	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	1.3	1.5	1.7	2.0	2.8	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	2.1	2.4	2.8	3.2	4.5	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.0	3.5	3.9	4.6	6.4	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.8	3.2	3.6	4.2	5.9	ns
$d_{TLH}^3$	Delta Low to High	0.016	0.016	0.02	0.022	0.032	ns/pF
$d_{THL}^3$	Delta High to Low	0.026	0.03	0.032	0.04	0.052	ns/pF
<b>5 V TTL Output Module Timing<sup>4</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	1.9	2.2	2.5	2.9	4.1	ns
$t_{DHL}$	Data-to-Pad High to Low	2.5	2.9	3.3	3.9	5.4	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	6.6	7.6	8.6	10.1	14.2	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.1	2.4	2.7	3.2	4.5	ns
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	7.4	8.4	9.5	11.0	15.4	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	1.9	2.2	2.5	2.9	4.1	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.6	4.2	4.7	5.6	7.8	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.5	2.9	3.3	3.9	5.4	ns
$d_{TLH}^3$	Delta Low to High	0.014	0.017	0.017	0.023	0.031	ns/pF
$d_{THL}^3$	Delta High to Low	0.023	0.029	0.031	0.037	0.051	ns/pF
$d_{THLS}^3$	Delta High to Low—low slew	0.043	0.046	0.057	0.066	0.089	ns/pF

**Notes:**

1. All -3 speed grades have been discontinued.
2. Delays based on 50 pF loading.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$

where  $C_{load}$  is the load capacitance driven by the I/O in pF

$d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
4. Delays based on 35 pF loading.

Table 2-38 • A54SX72A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
$t_{QCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.6	1.8	2.1	2.4	3.4	ns
$t_{QCHKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.5	ns
$t_{QPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{QPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{QCKSW}$	Maximum Skew (Light Load)	0.2	0.3	0.3	0.3	0.5	ns
$t_{QCKSW}$	Maximum Skew (50% Load)	0.4	0.5	0.5	0.6	0.9	ns
$t_{QCKSW}$	Maximum Skew (100% Load)	0.4	0.5	0.5	0.6	0.9	ns

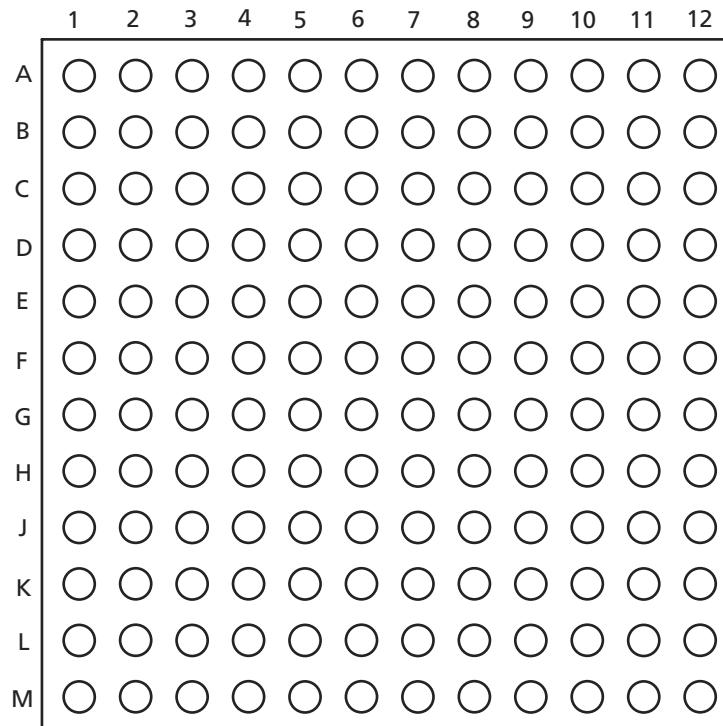
**Note:** \*All -3 speed grades have been discontinued.

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
75	I/O	I/O	I/O
76	I/O	I/O	I/O
77	I/O	I/O	I/O
78	I/O	I/O	I/O
79	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
80	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
81	GND	GND	GND
82	I/O	I/O	I/O
83	I/O	I/O	I/O
84	I/O	I/O	I/O
85	I/O	I/O	I/O
86	I/O	I/O	I/O
87	I/O	I/O	I/O
88	I/O	I/O	I/O
89	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
90	NC	NC	NC
91	I/O	I/O	I/O
92	I/O	I/O	I/O
93	I/O	I/O	I/O
94	I/O	I/O	I/O
95	I/O	I/O	I/O
96	I/O	I/O	I/O
97	I/O	I/O	I/O
98	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
99	GND	GND	GND
100	I/O	I/O	I/O
101	GND	GND	GND
102	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
103	I/O	I/O	I/O
104	I/O	I/O	I/O
105	I/O	I/O	I/O
106	I/O	I/O	I/O
107	I/O	I/O	I/O
108	I/O	I/O	I/O
109	GND	GND	GND
110	I/O	I/O	I/O

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
111	I/O	I/O	I/O
112	I/O	I/O	I/O
113	I/O	I/O	I/O
114	I/O	I/O	I/O
115	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
116	I/O	I/O	I/O
117	I/O	I/O	I/O
118	I/O	I/O	I/O
119	I/O	I/O	I/O
120	I/O	I/O	I/O
121	I/O	I/O	I/O
122	I/O	I/O	I/O
123	I/O	I/O	I/O
124	I/O	I/O	I/O
125	CLKA	CLKA	CLKA
126	CLKB	CLKB	CLKB
127	NC	NC	NC
128	GND	GND	GND
129	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
130	I/O	I/O	I/O
131	PRA, I/O	PRA, I/O	PRA, I/O
132	I/O	I/O	I/O
133	I/O	I/O	I/O
134	I/O	I/O	I/O
135	I/O	I/O	I/O
136	I/O	I/O	I/O
137	I/O	I/O	I/O
138	I/O	I/O	I/O
139	I/O	I/O	I/O
140	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
141	I/O	I/O	I/O
142	I/O	I/O	I/O
143	I/O	I/O	I/O
144	TCK, I/O	TCK, I/O	TCK, I/O

## 144-Pin FBGA

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Figure 3-6 • 144-Pin FBGA (Top View)

### Note

For Package Manufacturing and Environmental information, visit Resource center at  
<http://www.actel.com/products/rescenter/package/index.html>.

144-Pin FBGA			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
A1	I/O	I/O	I/O
A2	I/O	I/O	I/O
A3	I/O	I/O	I/O
A4	I/O	I/O	I/O
A5	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
A6	GND	GND	GND
A7	CLKA	CLKA	CLKA
A8	I/O	I/O	I/O
A9	I/O	I/O	I/O
A10	I/O	I/O	I/O
A11	I/O	I/O	I/O
A12	I/O	I/O	I/O
B1	I/O	I/O	I/O
B2	GND	GND	GND
B3	I/O	I/O	I/O
B4	I/O	I/O	I/O
B5	I/O	I/O	I/O
B6	I/O	I/O	I/O
B7	CLKB	CLKB	CLKB
B8	I/O	I/O	I/O
B9	I/O	I/O	I/O
B10	I/O	I/O	I/O
B11	GND	GND	GND
B12	I/O	I/O	I/O
C1	I/O	I/O	I/O
C2	I/O	I/O	I/O
C3	TCK, I/O	TCK, I/O	TCK, I/O
C4	I/O	I/O	I/O
C5	I/O	I/O	I/O
C6	PRA, I/O	PRA, I/O	PRA, I/O
C7	I/O	I/O	I/O
C8	I/O	I/O	I/O
C9	I/O	I/O	I/O
C10	I/O	I/O	I/O
C11	I/O	I/O	I/O
C12	I/O	I/O	I/O

144-Pin FBGA			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
D1	I/O	I/O	I/O
D2	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
D3	TDI, I/O	TDI, I/O	TDI, I/O
D4	I/O	I/O	I/O
D5	I/O	I/O	I/O
D6	I/O	I/O	I/O
D7	I/O	I/O	I/O
D8	I/O	I/O	I/O
D9	I/O	I/O	I/O
D10	I/O	I/O	I/O
D11	I/O	I/O	I/O
D12	I/O	I/O	I/O
E1	I/O	I/O	I/O
E2	I/O	I/O	I/O
E3	I/O	I/O	I/O
E4	I/O	I/O	I/O
E5	TMS	TMS	TMS
E6	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
E7	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
E8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
E9	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
E10	I/O	I/O	I/O
E11	GND	GND	GND
E12	I/O	I/O	I/O
F1	I/O	I/O	I/O
F2	I/O	I/O	I/O
F3	NC	NC	NC
F4	I/O	I/O	I/O
F5	GND	GND	GND
F6	GND	GND	GND
F7	GND	GND	GND
F8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
F9	I/O	I/O	I/O
F10	GND	GND	GND
F11	I/O	I/O	I/O
F12	I/O	I/O	I/O

144-Pin FBGA			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
G1	I/O	I/O	I/O
G2	GND	GND	GND
G3	I/O	I/O	I/O
G4	I/O	I/O	I/O
G5	GND	GND	GND
G6	GND	GND	GND
G7	GND	GND	GND
G8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
G9	I/O	I/O	I/O
G10	I/O	I/O	I/O
G11	I/O	I/O	I/O
G12	I/O	I/O	I/O
H1	TRST, I/O	TRST, I/O	TRST, I/O
H2	I/O	I/O	I/O
H3	I/O	I/O	I/O
H4	I/O	I/O	I/O
H5	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
H6	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
H7	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
H8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
H9	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
H10	I/O	I/O	I/O
H11	I/O	I/O	I/O
H12	NC	NC	NC
J1	I/O	I/O	I/O
J2	I/O	I/O	I/O
J3	I/O	I/O	I/O
J4	I/O	I/O	I/O
J5	I/O	I/O	I/O
J6	PRB, I/O	PRB, I/O	PRB, I/O
J7	I/O	I/O	I/O
J8	I/O	I/O	I/O
J9	I/O	I/O	I/O
J10	I/O	I/O	I/O
J11	I/O	I/O	I/O
J12	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>

144-Pin FBGA			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
K1	I/O	I/O	I/O
K2	I/O	I/O	I/O
K3	I/O	I/O	I/O
K4	I/O	I/O	I/O
K5	I/O	I/O	I/O
K6	I/O	I/O	I/O
K7	GND	GND	GND
K8	I/O	I/O	I/O
K9	I/O	I/O	I/O
K10	GND	GND	GND
K11	I/O	I/O	I/O
K12	I/O	I/O	I/O
L1	GND	GND	GND
L2	I/O	I/O	I/O
L3	I/O	I/O	I/O
L4	I/O	I/O	I/O
L5	I/O	I/O	I/O
L6	I/O	I/O	I/O
L7	HCLK	HCLK	HCLK
L8	I/O	I/O	I/O
L9	I/O	I/O	I/O
L10	I/O	I/O	I/O
L11	I/O	I/O	I/O
L12	I/O	I/O	I/O
M1	I/O	I/O	I/O
M2	I/O	I/O	I/O
M3	I/O	I/O	I/O
M4	I/O	I/O	I/O
M5	I/O	I/O	I/O
M6	I/O	I/O	I/O
M7	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
M8	I/O	I/O	I/O
M9	I/O	I/O	I/O
M10	I/O	I/O	I/O
M11	TDO, I/O	TDO, I/O	TDO, I/O
M12	I/O	I/O	I/O

256-Pin FBGA			
Pin Number	A54SX16A Function	A54SX32A Function	A54SX72A Function
K5	I/O	I/O	I/O
K6	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
K7	GND	GND	GND
K8	GND	GND	GND
K9	GND	GND	GND
K10	GND	GND	GND
K11	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
K12	I/O	I/O	I/O
K13	I/O	I/O	I/O
K14	I/O	I/O	I/O
K15	NC	I/O	I/O
K16	I/O	I/O	I/O
L1	I/O	I/O	I/O
L2	I/O	I/O	I/O
L3	I/O	I/O	I/O
L4	I/O	I/O	I/O
L5	I/O	I/O	I/O
L6	I/O	I/O	I/O
L7	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
L8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
L9	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
L10	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
L11	I/O	I/O	I/O
L12	I/O	I/O	I/O
L13	I/O	I/O	I/O
L14	I/O	I/O	I/O
L15	I/O	I/O	I/O
L16	NC	I/O	I/O
M1	I/O	I/O	I/O
M2	I/O	I/O	I/O
M3	I/O	I/O	I/O
M4	I/O	I/O	I/O
M5	I/O	I/O	I/O
M6	I/O	I/O	I/O
M7	I/O	I/O	QCLKA
M8	PRB, I/O	PRB, I/O	PRB, I/O
M9	I/O	I/O	I/O

256-Pin FBGA			
Pin Number	A54SX16A Function	A54SX32A Function	A54SX72A Function
M10	I/O	I/O	I/O
M11	I/O	I/O	I/O
M12	NC	I/O	I/O
M13	I/O	I/O	I/O
M14	NC	I/O	I/O
M15	I/O	I/O	I/O
M16	I/O	I/O	I/O
N1	I/O	I/O	I/O
N2	I/O	I/O	I/O
N3	I/O	I/O	I/O
N4	I/O	I/O	I/O
N5	I/O	I/O	I/O
N6	I/O	I/O	I/O
N7	I/O	I/O	I/O
N8	I/O	I/O	I/O
N9	I/O	I/O	I/O
N10	I/O	I/O	I/O
N11	I/O	I/O	I/O
N12	I/O	I/O	I/O
N13	I/O	I/O	I/O
N14	I/O	I/O	I/O
N15	I/O	I/O	I/O
N16	I/O	I/O	I/O
P1	I/O	I/O	I/O
P2	GND	GND	GND
P3	I/O	I/O	I/O
P4	I/O	I/O	I/O
P5	NC	I/O	I/O
P6	I/O	I/O	I/O
P7	I/O	I/O	I/O
P8	I/O	I/O	I/O
P9	I/O	I/O	I/O
P10	NC	I/O	I/O
P11	I/O	I/O	I/O
P12	I/O	I/O	I/O
P13	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
P14	I/O	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
A1	NC*	NC
A2	NC*	NC
A3	NC*	I/O
A4	NC*	I/O
A5	NC*	I/O
A6	I/O	I/O
A7	I/O	I/O
A8	I/O	I/O
A9	I/O	I/O
A10	I/O	I/O
A11	NC*	I/O
A12	NC*	I/O
A13	I/O	I/O
A14	NC*	NC
A15	NC*	I/O
A16	NC*	I/O
A17	I/O	I/O
A18	I/O	I/O
A19	I/O	I/O
A20	I/O	I/O
A21	NC*	I/O
A22	NC*	I/O
A23	NC*	I/O
A24	NC*	I/O
A25	NC*	NC
A26	NC*	NC
AA1	NC*	I/O
AA2	NC*	I/O
AA3	V <sub>CCA</sub>	V <sub>CCA</sub>
AA4	I/O	I/O
AA5	I/O	I/O
AA22	I/O	I/O
AA23	I/O	I/O
AA24	I/O	I/O
AA25	NC*	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AA26	NC*	I/O
AB1	NC*	NC
AB2	V <sub>CCI</sub>	V <sub>CCI</sub>
AB3	I/O	I/O
AB4	I/O	I/O
AB5	NC*	I/O
AB6	I/O	I/O
AB7	I/O	I/O
AB8	I/O	I/O
AB9	I/O	I/O
AB10	I/O	I/O
AB11	I/O	I/O
AB12	PRB, I/O	PRB, I/O
AB13	V <sub>CCA</sub>	V <sub>CCA</sub>
AB14	I/O	I/O
AB15	I/O	I/O
AB16	I/O	I/O
AB17	I/O	I/O
AB18	I/O	I/O
AB19	I/O	I/O
AB20	TDO, I/O	TDO, I/O
AB21	GND	GND
AB22	NC*	I/O
AB23	I/O	I/O
AB24	I/O	I/O
AB25	NC*	I/O
AB26	NC*	I/O
AC1	I/O	I/O
AC2	I/O	I/O
AC3	I/O	I/O
AC4	NC*	I/O
AC5	V <sub>CCI</sub>	V <sub>CCI</sub>
AC6	I/O	I/O
AC7	V <sub>CCI</sub>	V <sub>CCI</sub>
AC8	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AC9	I/O	I/O
AC10	I/O	I/O
AC11	I/O	I/O
AC12	I/O	QCLKA
AC13	I/O	I/O
AC14	I/O	I/O
AC15	I/O	I/O
AC16	I/O	I/O
AC17	I/O	I/O
AC18	I/O	I/O
AC19	I/O	I/O
AC20	V <sub>CCI</sub>	V <sub>CCI</sub>
AC21	I/O	I/O
AC22	I/O	I/O
AC23	NC*	I/O
AC24	I/O	I/O
AC25	NC*	I/O
AC26	NC*	I/O
AD1	I/O	I/O
AD2	I/O	I/O
AD3	GND	GND
AD4	I/O	I/O
AD5	I/O	I/O
AD6	I/O	I/O
AD7	I/O	I/O
AD8	I/O	I/O
AD9	V <sub>CCI</sub>	V <sub>CCI</sub>
AD10	I/O	I/O
AD11	I/O	I/O
AD12	I/O	I/O
AD13	V <sub>CCI</sub>	V <sub>CCI</sub>
AD14	I/O	I/O
AD15	I/O	I/O
AD16	I/O	I/O
AD17	V <sub>CCI</sub>	V <sub>CCI</sub>

**Note:** \*These pins must be left floating on the A54SX32A device.

